A Luminosity Detector for the PANDA Experiment at FAIR

Prometeusz Jasinski on behalf of the PANDA collaboration 25.02.2014

INSTR14 BINP, Novosibirsk



GEFÖRDERT VOM

Bundesministerium für Bildung und Forschung



PANDA – Experiment at FAIR



PANDA – Experiment at FAIR



PANDA – Experiment at FAIR



Determination of Luminosity





Elastic scattering as reference



Particle track reconstruction



top view

Measurement close to the Beam

Requirements for the detector:

minimal track distortion by material maximum acceptance elastic events

measurement at smallest angles

Measurement close to the Beam

Requirements for the detector:

minimal track distortion by material

maximum acceptance elastic events

measurement at smallest angles

Requirements by the storage ring:

high vacuum < 10⁻⁹ mbar

maximum acceptance of the beam

slow changes of beam pipe diameter



PANDA beam pipe



PANDA beam pipe



Vacuum Box Prototype



Beam Pipe Prototype



Differential Pumping Scheme



First Pumping Tests



First Pumping Tests



Retractable Detector Halves



Retractable Detector Halves



Retractable Detector Halves





Displacement Measurement in Vacuum

Capacitive probes: Capacitec 208-ACU

2 mm range ~ 40 nm resolution

Aquisition via 18-bit differential ADC and microcontroller with CAN interface







DCS via Epics: Florian Feldbauer Sat 9:00 am





Cooling of HV-MAPS

 $2 \ x \ 2 \ cm^2$ individual HV-MAPS (50 $\mu m)$ 400 in total

digitization on chip (more: Tobias Weber today 3:35 pm)

2011

expected power consumption : 2 mW/mm²

glued on a diamond wafer (200 µm) (high thermal conductivity)

module

tracking plane

Simulations on cooling





Simulations vs. Reality



Testing contact materials for the module clamp and a copper dummy

Simulations vs. Reality



A Support Structure as a Heat Sink



Production of Heat Sink Supports



Original idea: LHCb Velo Detector

melting AIMg4.5Mn alloy for 730°C 90 min in argon atmosphere





Prometeusz Jasinski

Production of Heat Sink Supports



Track Reconstruction



Material Budget of one Plane



 X/X_0 (2 sides) = 0.37% (eq. 350 µm thick silicon)

Resolution at the Detector



Resolution after back propagation



Fit of the Luminosity at 1.5 GeV/c



What's next?

Upcoming tests:

- A full cooling circuit at full load
- More on the mechanical precision
- Glued flex print vacuum feed throughs
- Gluing of thin sensors
- Systematic fit studies

Our goal: finalizing our TDR this year!

Simulations with PANDAROOT (Geant)



Differential Pumping Sheme



Cooling stations for cooling liquids



versus

Cooling power @-20°C 1.9 kW 2.2kW max. pumping speed 105 l/min 45 l/min max. pumping pressure 2.5 bar(special version) 2.9 bar





Geometrical Acceptance



Acceptance at 1.5 GeV/c beam momentum





Welding tube inside



Melting in a copper mold







Melting in a SS mold with inert gas

The biggest fun we had: "Baking cookies"



Question was: Can we melt aluminum cooling blocks around a . stainless steel pipe?

Prototype 5: Vacuum

melting / pressurized

freezing.. Perfect!

As Aluminum crimps more we must get a nice crimp contact though?

Prototype 4: Mg vapor bubbles due to vacuum







Result of vacuum baking: A: Perfect contact around the pipe, B: perfect contra shape of the mold

- Aluminum cookie recipe:
 - Take a stainless steel tin and fill with aluminum blocks or bars (AIMg4,5Mn)
 - Melt aluminum under vacuum <1e-3 mbar at 700°C for 1.5 hour
 - Apply 1 bar Argon pressure for 10 minutes
 - Switch of oven and let cool down.
 - Remove cookies from the mold and machine

"The cookie bakery"

NI

erlaat@nikhef.

CERN

First Pumping Tests

